



CHENMKO ENTERPRISE CO.,LTD

Halogens free devices

SURFACE MOUNT

SCHOTTKY BARRIER RECTIFIER

VOLTAGE RANGE 20 - 40 Volts CURRENT 2.0 Amperes

**SSM22LGP
THRU
SSM24LGP**

FEATURES

- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- * For surface mounted applications
- * Low profile package
- * Built-in strain relief
- * Metal silicon junction, majority carrier conduction
- * Low power loss, high efficiency
- * High current capability, low forward voltage drop
- * High surge capability
- * For use in low voltage high frequency inverters, free wheeling, and polarity protection applications
- * High temperature soldering guaranteed : 260°C/10 seconds at terminals

MECHANICAL DATA

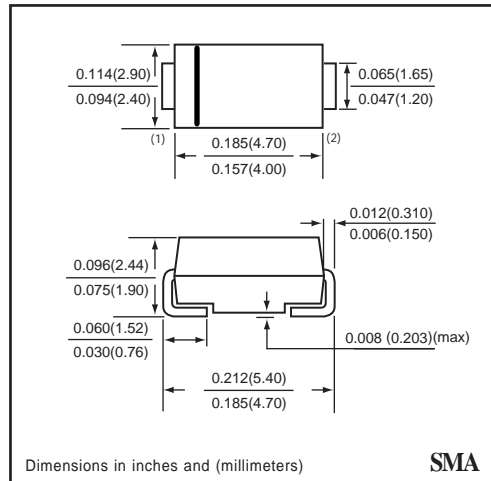
Case: JEDEC SMA molded plastic
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Weight: 0.002 ounce 0.064 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase, half wave, 60 Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.



SMA



Dimensions in inches and (millimeters)

SMA

MAXIMUM RATINGS (At TA = 25°C unless otherwise noted)

RATINGS	SYMBOL	SSM22LGP	SSM23LGP	SSM24LGP	UNITS
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	20	30	40	Volts
Maximum RMS Voltage	V _{RMS}	14	21	28	Volts
Maximum DC Blocking Voltage	V _{DC}	20	30	40	Volts
Maximum Average Forward Rectified Current	I _O	2.0			Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	60			Amps
Typical Junction Capacitance (Note 2)	C _J	250			pF
Typical Thermal Resistance (Note 1)	R _{θJL}	20			°C / W
Operating and Storage Temperature Range	T _J ,T _{STG}	-65 to +125			°C

ELECTRICAL CHARACTERISTICS (At TA = 25°C unless otherwise noted)

CHARACTERISTICS	SYMBOL	SSM22LGP	SSM23LGP	SSM24LGP	UNITS
Maximum Instantaneous Forward Voltage at 2.0 A DC	V _F	0.40			Volts
Maximum Average Reverse Current at Rated DC Blocking Voltage	@ TA = 25°C	1.0			mAmps
	@ TA = 100°C	10			mAmps

NOTES : 1. Thermal Resistance (Junction to Lead) : PC Board Mounted on 0.2 X 0.2" (5 X 5mm) copper pad area.
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0 volts.

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RATING CHARACTERISTIC CURVES (SSM22LGP THRU SSM24LGP)

FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

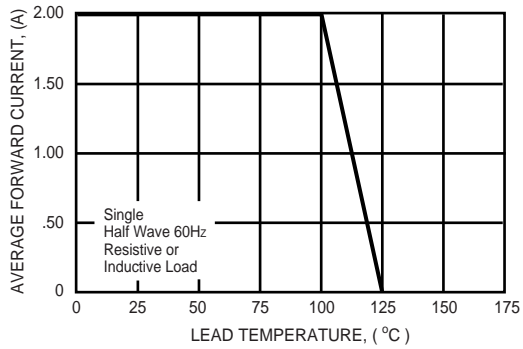


FIG. 2 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

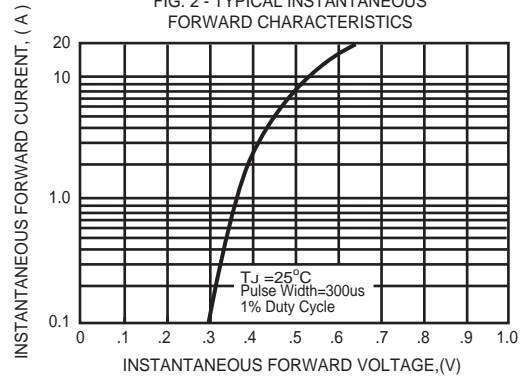


FIG. 3 - TYPICAL REVERSE CHARACTERISTICS

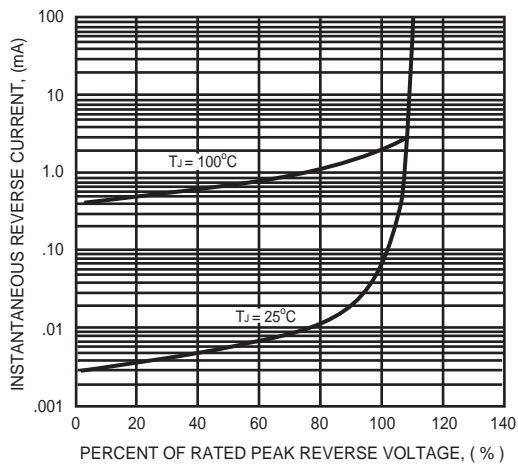


FIG. 4 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

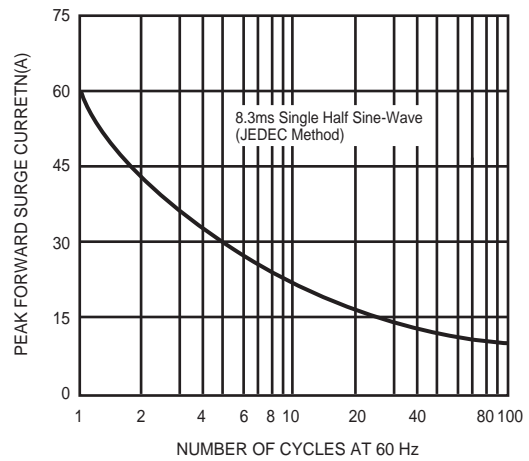


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

